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## What is claimed is:

- 1. A pressure-sensitive adhesive composition comprising polymers and/or copolymers based at least predominantly on (meth)acrylic acid and/or derivatives thereof, wherein said composition possesses an outgassing level of not more than 50  $\mu$ g/g in total, preferably less than 10  $\mu$ g/g, when said composition is measured by the tesa method.
- 2. The pressure-sensitive adhesive composition as claimed in claim 1, wherein the polymers and/or copolymers are prepared using at least the following monomers:
  - (a) from 65 to 100% by weight of acrylic and/or methacrylic acid derivatives of the general formula

$$O$$
 $R_2$ 

where  $R_1$  = H or  $CH_3$  and  $R_2$  = an alkyl chain of 2 to 20 carbon atoms,

- (b) from 0 to 35% by weight of vinyl compounds containing functional groups.
- 3. A process for preparing a pressure-sensitive adhesive composition as claimed in at least one of the preceding claims, using a polyacrylate solution obtainable by free-radical addition polymerization, which comprises a concentration step in which
  - after polymerization, an entrainer is added to the polyacrylate solution,
  - the entrainer-admixed polyacrylate solution is passed into an extruder in which said solution is subjected to a carrier distillation,
  - the concentration thus produces a polyacrylate composition which is processed further from the melt.
- 4. The process as claimed in claim 3, wherein in at least one step further following concentration, a postpurification is conducted by adding the same entrainer again, or a further entrainer, to the concentrated polyacrylate composition and carrying out a further carrier distillation in the extruder,

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- preferably choosing in each case higher temperatures and lower vacuums than in the preceding distillation step.
- 5. The process as claimed in at least one of claims 3 and 4, wherein at least the extruder in the concentration step is a corotating or counterrotating twinscrew extruder.
  - 6. The process as claimed in at least one of claims 3 to 5, wherein steam is used as entrainer.
- 7. The process as claimed in at least one of claims 3 to 6, wherein
  - the concentrated polyacrylate composition is applied to a backing material
  - ◆ and the polyacrylate composition on the backing material is subjected to a crosslinking reaction.
- 8. The process as claimed in claim 7, wherein crosslinking is carried out using UV light in a wavelength range from 250 to 400 nm, with the proviso that the output of light in the wavelength range from 300 to 400 nm makes up at least 70%, very preferably 90%, of the total irradiated light output.
- 9. An adhesive tape, in particular for use in the electronics industry, comprising a film, applied to one or both sides of a backing material, of a pressure-sensitive adhesive composition as claimed in either of claims 1 and 2.
- 10. The adhesive tape as claimed in claim 9, comprising
  a backing material having a very low outgassing tendency, preferably of less than
  5 μg/g.